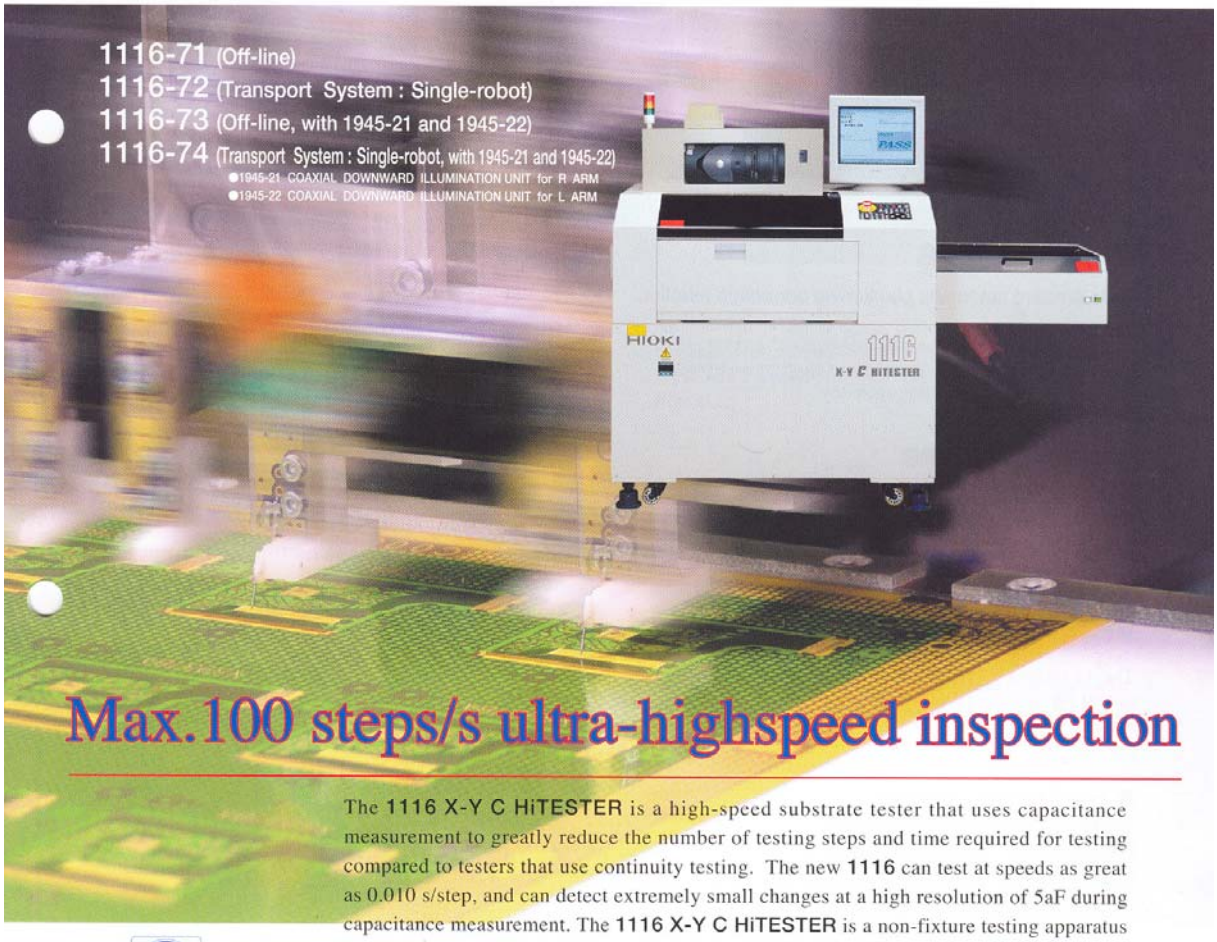
HIOKI

Two-arm model

New

1116 X-Y C HiTESTER

Automatic Testing Equipment



Max.100 steps/s ultra-highspeed inspection

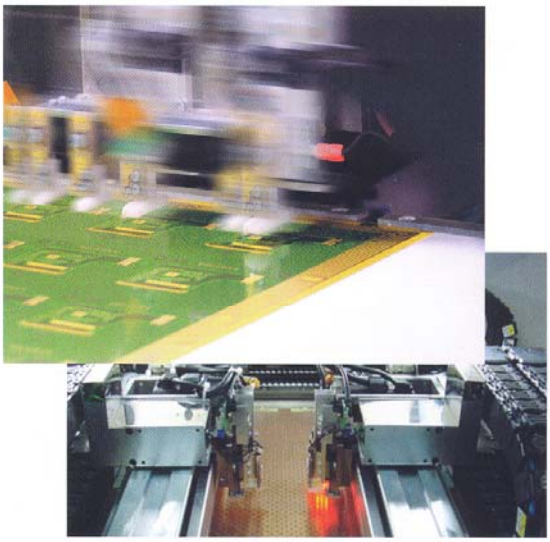
The **1116 X-Y C HiTESTER** is a high-speed substrate tester that uses capacitance measurement to greatly reduce the number of testing steps and time required for testing compared to testers that use continuity testing. The new **1116** can test at speeds as great as 0.010 s/step, and can detect extremely small changes at a high resolution of 5aF during capacitance measurement. The **1116 X-Y C HiTESTER** is a non-fixture testing apparatus which not only yields very low running costs, but also has a high-speed soft landing function that minimizes impressions resulting from probe impact. Because there are no restrictions on board type, it can be used for testing plastic, ceramic, and liquid crystal glass panels.

ISO14001
JQA-E-90091

http://www.hioki.co.jp/

HIOKI company overview, new products, environmental considerations and other information are available on our website.

From ordinary bare boards to high-density BGA, CSP, or MCM packages Accommodates flexible boards too



■ Maximum measurement speed of 0.014 s/step

The **1116 X-Y C HiTESTER** can test at speeds as great as 0.014 s/step.

(with 0.1 mm movement and all two arms used simultaneously during capacitance measurement)

■ Capacitance measurement resolution of 5aF(1aF=10^{-6}pF)

Since the variation in capacitance accompanying a fault may be extremely small, high resolution is required for capacitance measurement. With a high resolution of 5aF, the **1116 X-Y C HiTESTER** can detect extremely small variations.

■ High-precision probing

With a minimum pad diameter of just ±20mm, the 1116's high-precision design assures accurate probing of fine pitch pattern pads.

■ A standard automatic positioning correction function

Together with a high-precision mechanism, the automatic positioning correction function assures an additional degree of probing accuracy.

■ Vacuum clamping

The board being tested are fixed using the vacuum clamping method. Since chucks are not required to secure the board during carrying and testing, all areas on the board can be tested.

■ Large testing area

The **1116 X-Y C HiTESTER** has a testing area of up to 610 (W) × 510 (D) mm, allowing the testing of large boards.

■ Two keyboard heights

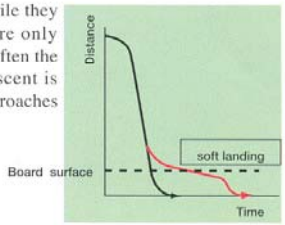
The keyboard can be placed at two heights to accommodate both standing and sitting working postures.

■ Minimal probing impact

Probing impact is kept to a minimum with the high-speed soft landing function and shock-absorbing probes.

● High-speed soft landing function

The probes are raised while they are being moved, and are only lowered for testing. To soften the impact, the speed of descent is lessened as the probe approaches the target.



■ Accommodates boards as thin as 0.1 mm

Boards with thicknesses ranging from 0.1 mm to 3.2 mm can be tested, making it possible to test thin boards, such as flexible circuit boards.

■ A variety of electrical measurements

In addition to capacitance measurement, the **1116 X-Y C HiTESTER** can also measure resistance, inductance, diode VF, and voltage.

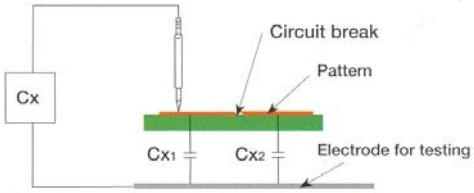
■ Loading system is standard outfit

(1116-72,1116-74)

A single axis actuator is used to move the vacuum clamping jig. Boards to be tested can easily be set from outside the main unit.

High-speed pattern testing using capacitance measurement

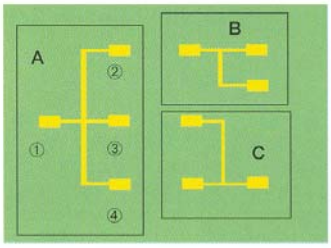
Each printed circuit pattern has a particular capacitance, proportional to its area, with respect to the electrically insulated electrode used for testing. If there are circuit breaks, or shorts, then the area of the pattern will differ, and the capacitance will change correspondingly. Therefore, by comparing the capacitance values with those of a reference board, the pattern can be checked for continuity. Since the floating capacitance of the pattern is extremely low, a special-purpose jig with vacuum clamping is used to obtain stable measurement values.



When there is no circuit break, Cx = Cx1 + Cx2
When there is a circuit break, Cx = Cx1
In the case of a circuit break, the capacitance is detected as being lower than that of a reference board; if there is a short circuit, it will be detected as higher.

Testing steps

Using the conductivity measurement method to check pattern A in the figure for continuity requires three steps, measuring 1-2, 1-3, and 1-4, and the same is required for patterns B and C. Checking for short circuits in A, B, and C requires another three steps, testing A-B, A-C, and B-C. Thus, if the circuit is complex, the number of steps is very large. Using the capacitance measurement method, discontinuity and short circuit testing can be achieved by measuring at just the endpoints of each pattern.



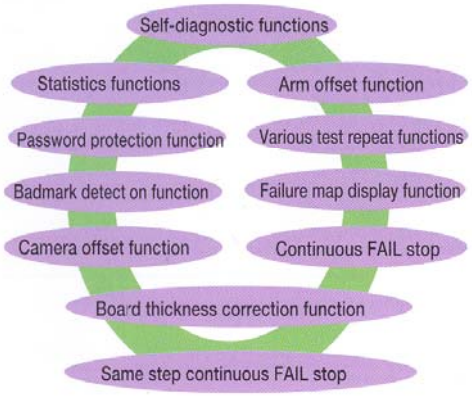
■ Comparison of testing steps

For 100 networks with all 500 nodes

	Conductivity measurement method	Capacitance measurement method
Discontinuity testing	All nodes in the same network 500 - 100 = 400	Discontinuity and short circuit testing for capacitance measurements of all nodes. 500
Short circuit testing	nCr = $_{100}C_2$ 100 ×(100-1)/2 = 4950	
Testing steps	5350	500

As shown in the figure below, if there is a discontinuity near one end of the pattern, then there is very little change in the capacitance measured from a, but a large change measured from b.

Convenient features



Testing data with FLY LINE

FLY LINE searches for network information and end point coordinates from various types of garber and NC data, and automatically extracts the testing points required to conduct pattern tests for printed substrates. **FLY LINE** produces test data with great efficiency.

Supports unattended operation
when used with a handler

1116 Specifications

No. of arms	2
No. of probes	2
No. of test steps	Max. 40,000 (300,000 for continuous testing)
Test ranges	DC measurement function Resistance :400μΩ to 40MΩ Capacitance :4μF to 400mF Diodes, transistors (VF) : 0 to 25V Zener diodes (VZ) : 0 to 25V Short circuit :400mΩ to 40kΩ Open circuit :4Ω to 4MΩ Voltage : 0 to 25V AC measurement function Resistance :100Ω to 100MΩ Capacitance :10 fF to 10μF Coils :10μH to 100H
Measurement signal	DC constant voltage : 100mV/400mV(2 ranges) DC constant current :200nA to 200mA(13 ranges) AC constant voltage : 1V rms /10 V peak (2 ranges) AC frequency :160Hz/1.6kHz/16kHz/160kHz
Measurement ranges	DC voltage measurement : 800μV to 25V f.s.(8 ranges) DC current measurement : 100nA to 25mA f.s.(7 ranges) AC current measurement : 10μA to 10mArms (4 ranges) for 1 Vrms : 100μA/1mA (2 ranges) for 10 Vpeak
Decision range setting	-99.9% to +999.9% or absolute value
Measurement time	Min. 0.010 s/step (0.1 mm movement with 2-arm simultaneous probing during capacitance measurement)
Minimum pad diameter	20μm
Minimum movement step	XY : 1.00μm/pulse Z : 6.00μm/pulse
Minimum Probing pitch	50 μm Using a link-type probe. Proper operation is subject to certain conditions.

Probe work area	610(W)×510(D)mm
Fixed and movable boards	Thickness : 0.1 to 3.2 mm External dimensions : 50×50mm to 610×510mm Component mounting limits : Upper surface ; 12 mm(including board thickness) Lower surface ; not possible Board weight : 2.0 kg max.
Board-carrier	Vacuum jig horizontal carrier with a single axis actuator
Positioning correction	Automatic positioning correction function
Safety devices	Emergency stop switch, safety cover (of anti-static resin), interference prevention (stops arms from colliding)
External memory	FDD, HDD, CD-ROM
Display	17-inch color display
Power supply	200 V AC±10%(single phase) 50/60Hz Power consumption :3kVA
Pneumatic system	Primary pressure: 0.5 to 0.99 MPa (dry air)
Air consumption	Max.0.3Nl/min.
Operating environment	Temperature : 23±10 °C Humidity : 75%rh or less(no condensation) Atmosphere : Avoid use subject to dust, vibration, or corrosive gases Floor strength: at least 500 kg/m²
Accessories	Thermal mini printer, printer cable, grease, grease can, arm offset board, keyboard, PS/2 mouse, mouse pad, mouse pocket, PC accessories, Setup disk, leveling jacks (4), color display (17 inch), power cord (loose ends, 3 m), spare fuse, impression sheets
Unit dimensions	1465 (W) ×1230 (H)× 1110 (D) mm approx.
Mass	1000 kg approx.

*Air is required when using the stamp unit.

1116 X-Y C HiTESTER

The 1116 does not include a printer. please consult with Hioki regarding availability of English printers.

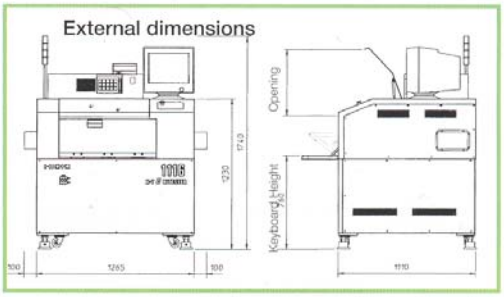
● Factory options

1355-01 VACUUM PUMP (AC200 V, three phase)
1933-20 INSULATION MEASUREMENT UNIT
1941-31 STAMP UNIT for R ARM
1941-32 STAMP UNIT for L ARM
1941-35 STAMP UNIT WITH THE CAP for L ARM
1945-21 COAXIAL DOWNWARD ILLUMINATION UNIT for R ARM
1945-22 COAXIAL DOWNWARD ILLUMINATION UNIT for L ARM
1946-04 MONITOR CAMERA
1947-23 1.2 POWER LENS UNIT for R ARM
1947-24 1.2 POWER LENS UNIT for L ARM

● Options

1139-03 1116-7x DATA COMPOSITION SOFTWARE
1139-53 FL-Link4 FLY-LINE LINK SOFTWARE
1330-01 MEASUREMENT SECTION CALIBRATION UNIT
1356 MAINTENANCE TOOL SET
1172-66 LINK PROBE (for L and R ARM)
1172-67 DOUBLE LINK PROBE (for L and R ARM)
1172-68 LINK PROBE WITH BLADE (for L and R ARM)
1172-69 DOUBLE LINK PROBE WITH BLADE (for L and R ARM)
1172-70 SHOCK-ABSORBING SINGLE NEEDLE PROBE (SK)
1172-71 SHOCK-ABSORBING SINGLE NEEDLE PROBE (WC)
1172-72 SHOCK-ABSORBING TRIANGULAR PYRAMID PROBE (SK)
1172-74 PROBE FOR CALIBRATION (for L and R ARM)

External dimensions



1172-75 SHOCK-ABSORBING SINGLE NEEDLE PROBE (HP)
1172-76 SHOCK-ABSORBING SINGLE NEEDLE PROBE (HP SR10)
1172-77 SHOCK-ABSORBING SINGLE NEEDLE PROBE (WC SR10)
1172-80 PROBE (Flat spring,3mm stroke)
1172-81 LINK PROBF (Link, high-speed version)
1172-83 DOUBLE LINK PROBE (Double link,35μm between terminals)
1134-02 IMPRESSION SHEETS
1164-02 ONE-WAY CLUTCH
1164-03 PROBE ATTACHMENT
1196 RECORDING PAPER (25m,10rolls)
1350 OFFSET BOARD (t=2mm)
1350-01 OFFSET BOARD (t=1mm)

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